

10/564236

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

AP/20 Rec'd PCT/PTO 10 JAN 2006

Appl. No. : Unassigned Confirmation No. Unassigned
First Inventor : SOLO DE ZALDIVAR Jose
Filed : Concurrently
TC/A.U. : Unassigned
Examiner : Unassigned

Docket No. : DE03 0254 US1
Customer No. : 24738

Title: Metal Bump with an Insulation for the Side Walls and Method
of Fabricating a Chip with such a Metal Bump

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

PRELIMINARY AMENDMENT

Sir:

Prior to calculation of the filing fee and examination please amend the above-identified application as follows:

Amendments to the Specification there are no amendments in this paper.

Amendments to the Claims begin on page 2 of this paper.

Remarks/Arguments begin on page 4 of this paper.